

WBG Products Validation by Double Pulse Test

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Marketing of WBG Products
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Company Profile

Diodes delivers high-quality (discrete, analog, and mixed signal) semiconductor products to the world's leading companies in the automotive, industrial, computing, consumer electronics, and communications markets

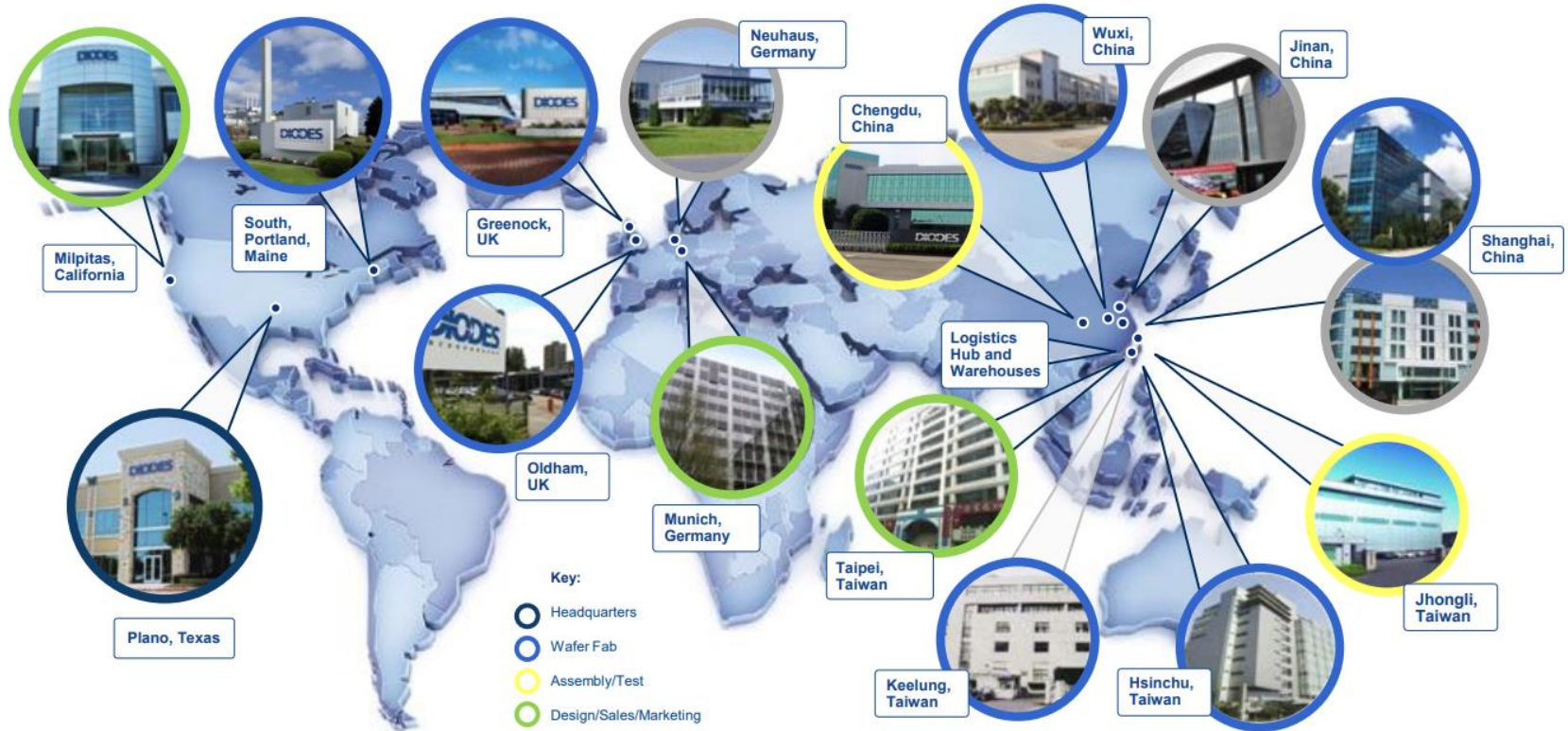


Vision: Profitability Growth to Maximize Shareholder Value

Our Core Values: Integrity, Commitment, Innovation

Global Organization

- Headquartered in Plano, TX; 32 locations globally
- Manufacturing in US, UK, Germany, China, and Taiwan



Products



Automotive Applications Driving Growth

Focus Applications:

Connected Driving

- **ADAS** (Advanced Driver Assistance Systems)
- **Telematics**
- **Infotainment Systems**

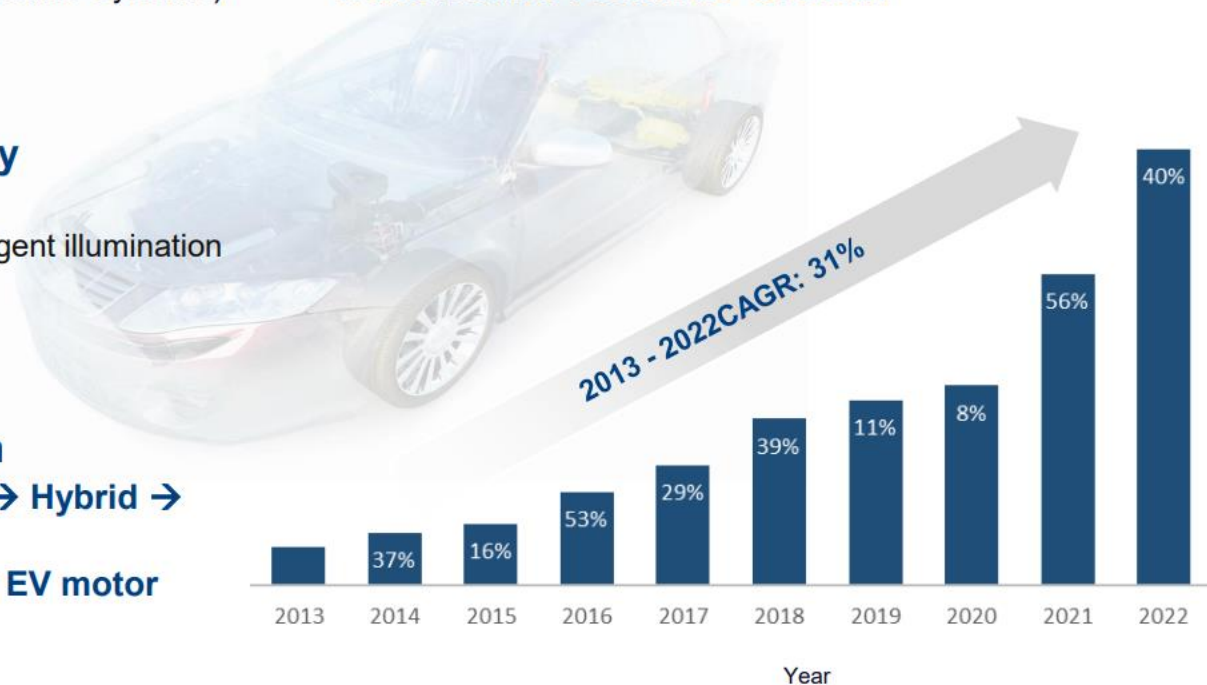
Comfort, Style, and Safety

- **Lighting**
 - Migration to LED and intelligent illumination
- **BLDC motor control**
 - Migration from Brushed to Brushless DC Motors

Electrification/Powertrain

- **Conventional Powertrain → Hybrid → Electrification**
- **Power Module Inverter for EV motor**
- **Battery management**
 - Move to 48V battery

Automotive Revenue Growth



Our Sustainability Commitment

We view sustainability as a competitive advantage and have adopted a sustainability-oriented approach to assess and address related risks that may influence our operational activities, business results, and financial performance.

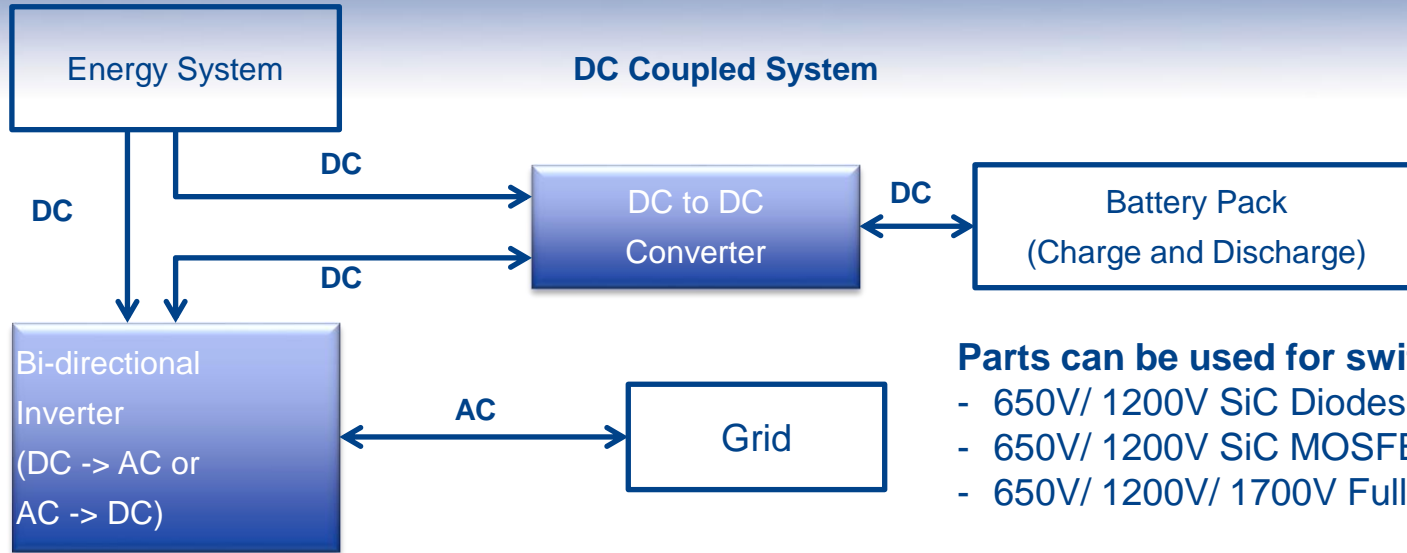


- Key focus areas regularly reviewed by our Board of Directors
- Instituted a cross-functional Sustainability Steering Team to address the sustainability related risks and opportunities
- The Sustainability Steering Team provides periodic updates to the Board of Directors

What Will Our Products Be....?

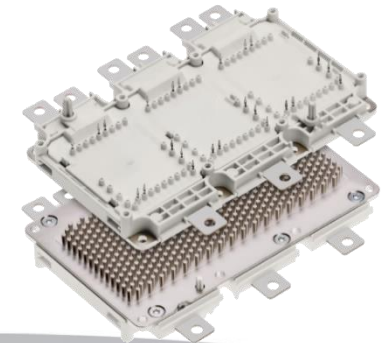
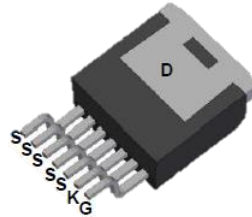
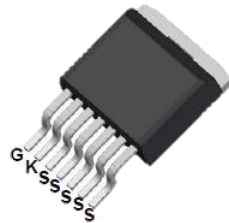
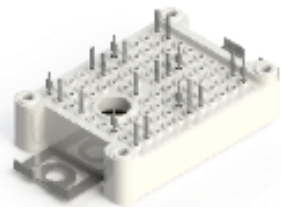


SiC Applications



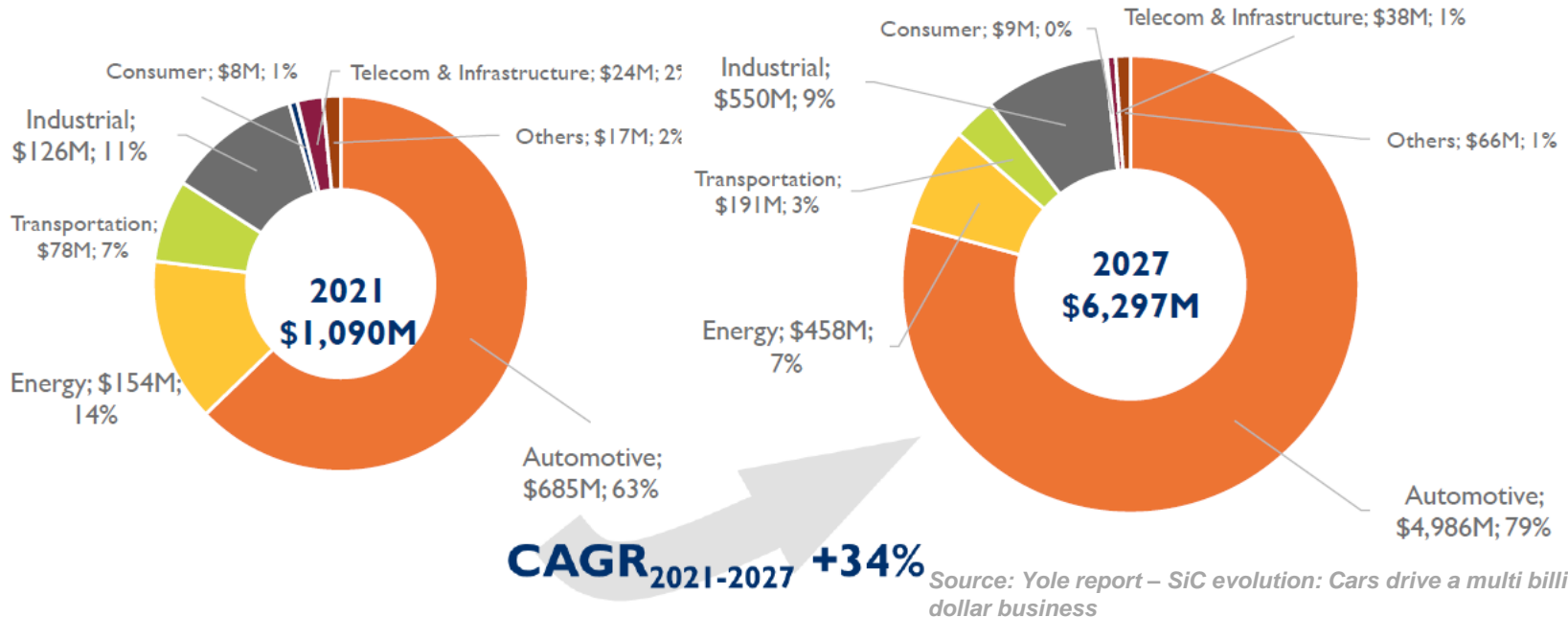
Parts can be used for switching:

- 650V/ 1200V SiC Diodes
- 650V/ 1200V SiC MOSFETs
- 650V/ 1200V/ 1700V Full SiC Modules

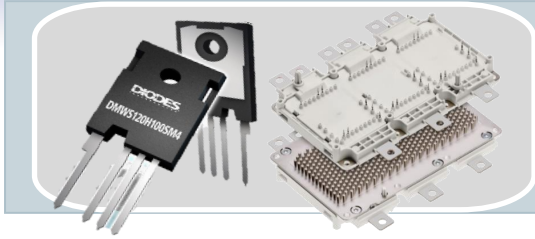


Power SiC Device Market (\$M)

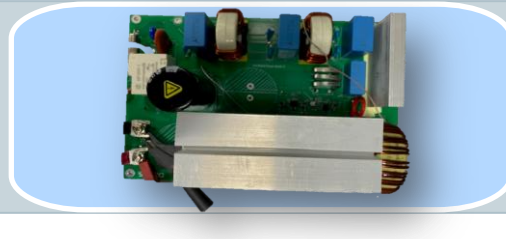
- Split by Application:



Design Products Fit Requirement



Power Components



Sub-Systems



Motors
(Reference: Tesla Motor)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_C = +25^\circ\text{C}$	208	W
	$T_C = +100^\circ\text{C}$	83	
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	25.5	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case (Note 5)	$R_{\theta JC}$	0.6	
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

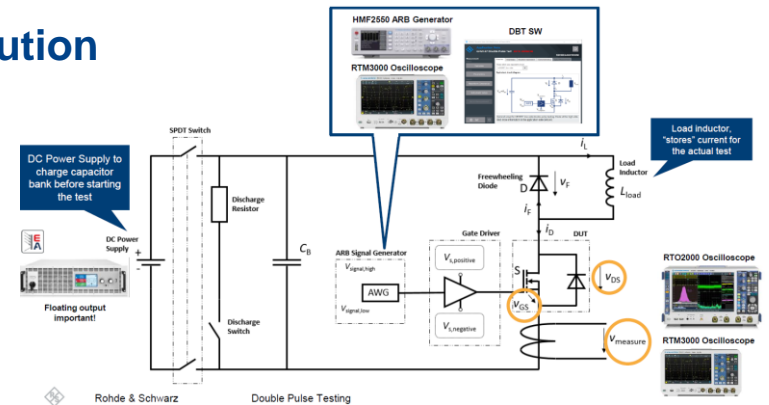
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV_{DS}	1200	—	—	V	$V_{GS} = 0V, I_D = 100\mu\text{A}$
Zero Gate Voltage Drain Current	I_{DSS}	—	—	100	μA	$V_{DS} = 1200V, V_{GS} = 0V$
Gate-Source Leakage	I_{GSS}	—	—	± 200	nA	$V_{GS} = +15/-4V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	$V_{GS(TH)}$	1.8	2.5	3.5	V	$V_{DS} = V_{GS}, I_D = 5mA$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	—	80	100	m Ω	$V_{GS} = 15V, I_D = 20A$
Diode Forward Voltage	V_{SD}	—	4.06	—	V	$V_{GS} = -4V, I_S = 10A$
Transconductance	g_{fs}	—	3.8	—	S	$V_{DS} = 20V, I_D = 20A$



Name	Details
Measurements according to IEC 60747-8 and IEC 60747-9	<ul style="list-style-type: none"> ▶ Turn-on and turn-off delay times ▶ Rise and fall time ▶ Turn-on energy and Turn-off energy ▶ Reverse recovery time ▶ Reverse recovery charge ▶ Reverse recovery energy ▶ Reverse recovery current
Gate charge	<ul style="list-style-type: none"> ▶ Gate charge ▶ Plateau charge ▶ Total charge ▶ V_g vs. Q_g
Extraction of DUT stray inductance	
dv/dt and di/dt	
(Dynamic on-resistance) according to JC70 standards	
Switching locus	<ul style="list-style-type: none"> ▶ I_d and V_{ds} vs. t ▶ I_g and V_{gs} vs. t ▶ Energy vs. t ▶ I_d vs V_{ds} (switching locus)

Dynamic Parameters Measurement on SiC Devices

- The methodology and theory of dynamic characteristics measurement of SiC is similar with that of Si semiconductors.
- Double pulse test is the preferred test method to measure the switching parameters and evaluate the dynamic behaviors of power devices.
- But fast switching time of SiC power components increase the number of effects influencing the measurement.
 - Stray inductances of DC-link
 - Smaller losses => high measurement resolution
 - Bandwidth voltage and current probes
 - ...



Theory of Double Pulse Test

- Double pulse test is a tool which enables a power switch to be turned on and off at different current levels as shown in figure 1.

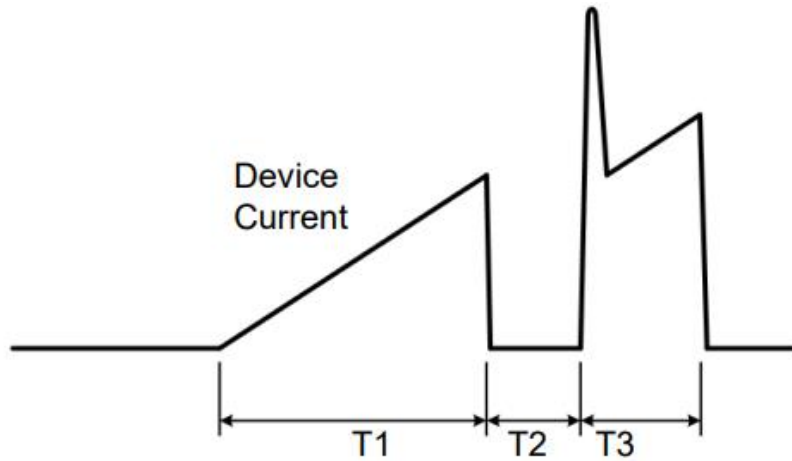
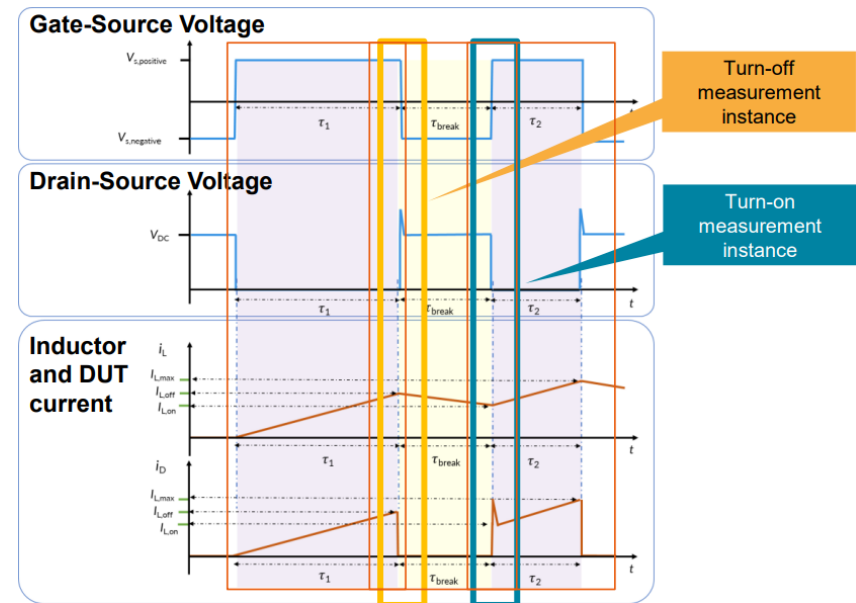


Figure 1: Double pulse waveform

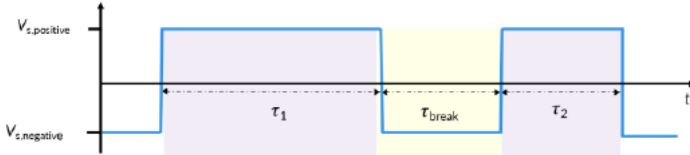


Why Not Single Pulse?

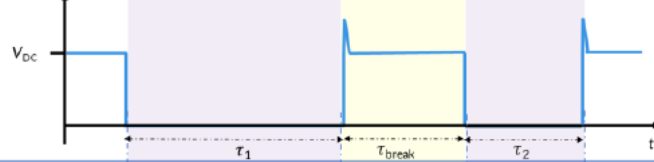
- ✓ **In most power devices, inductive load is bigger. When DUT turn off, inductive current continue to flow, causing diode to turn ON.**
- ✓ **Turning ON the DUT at time stage, the diode will have a reverse recovery process. This is unavailable if we only do a single pulse test.**

DPT Wave Form

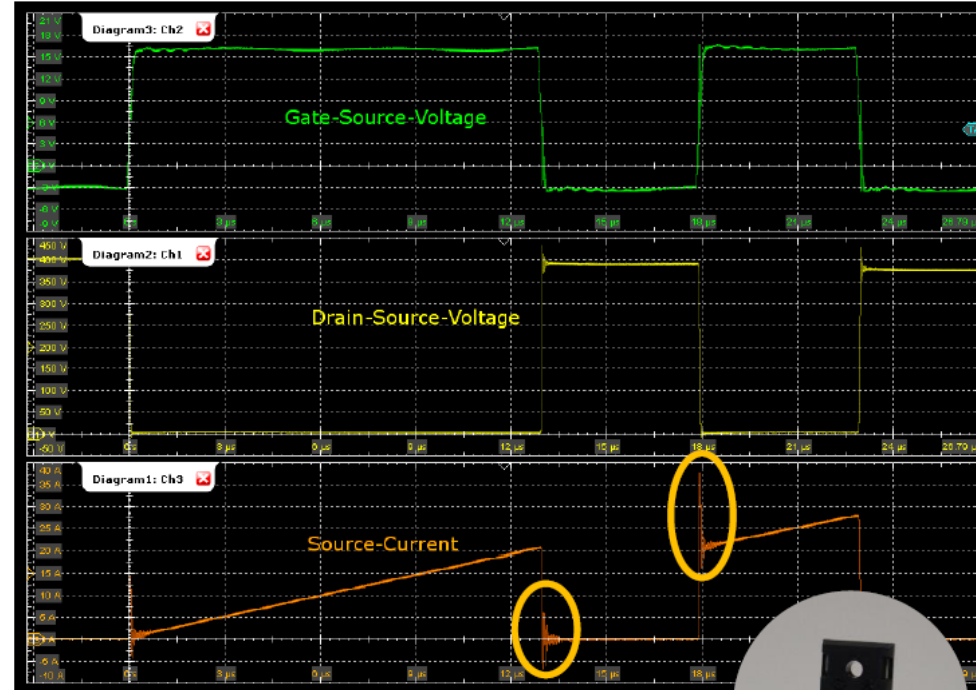
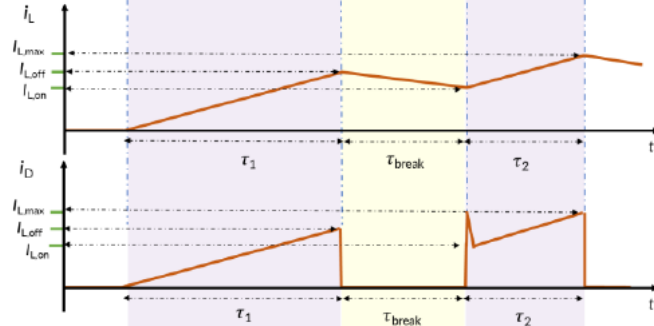
Gate-Source Voltage



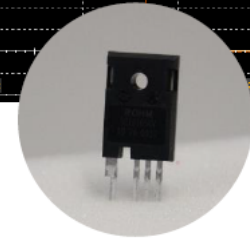
Drain-Source Voltage



Inductor and DUT current

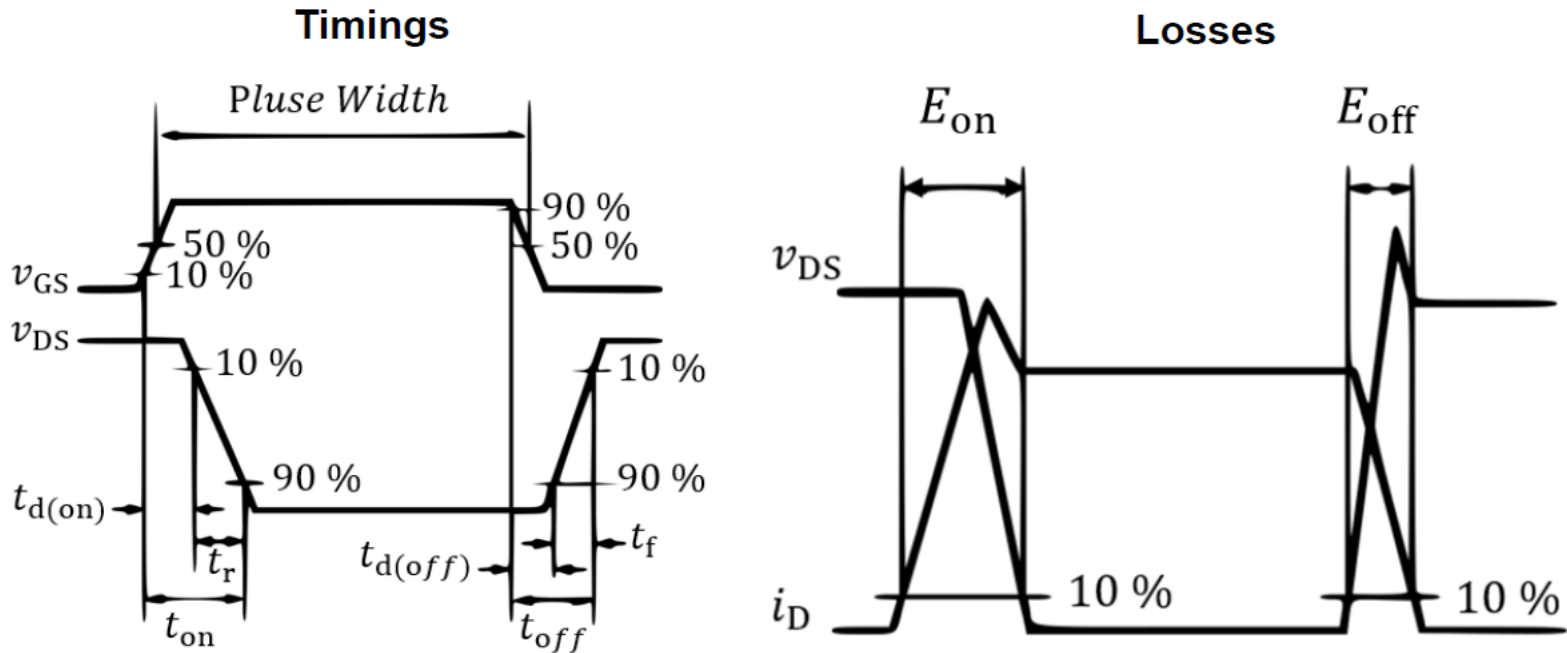


Reference: R&S Report - 掌握雙脈衝測試原理和方法



Rohde & Schwarz Double Pulse Testing

Turn-on And Turn-off Timing And Energy



Definition from IEC 60747-8 for MOSFET

Conclusion

- From design point of view, double pulse test helps power component designers to get relevant data of switching.
- With the dynamic data, components designers can get the sweet point between reliability and efficiency.
- On SiC products, the conduction and switching loss is much smaller. It is important to have a test system to ensure measurement accuracy.



GaN Performance



Thank you

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